BFCN-1801+

50Ω 1400 to 2320 MHz

The Big Deal

- Small size 3.2mm x 1.6mm
- Pass band (1400-2320 MHz)
- · High rejection over wide band



Product Overview

The BFCN-1801+ LTCC Band Pass Filter achieves a miniature size and high repeatability of performance. Wrap-around terminations minimize variations in performance due to parasitics. Covering 1400 to 2320 MHz, these units offer excellent rejection over a wide stopband.

Key Features

| Feature | Advantages |
|------------------------------------|---|
| Small Size (3.20mm x1.6 mm) | Allows for high layout density of circuit boards, while minimizing effects of parasitics. |
| Rejection peaks close to pass band | Provides good rejection of signals close to the pass band, for improved system performance. |
| Wide stopband | No regrowth at 2nd and 3rd harmonics permits filter to be used in presence of wideband undesired signals. |
| LTCC construction | Provides a rugged package that is well suited for tough environments including high humidity and high temperature extremes. |

Ceramic

Bandpass Filter

1400 to 2320 MHz 50Ω

Features

- Small size
- Temperature stable
- Hermetically sealed
- LTCC construction

Applications

- Harmonic Rejection
- Transmitters / Receivers

BFCN-1801+



Generic photo used for illustration purposes only

CASE STYLE: FV1206-7

+RoHS Compliant
The +Suffix identifies RoHS Compliance. See our web site for RoHS Compliance methodologies and qualifications



Maximum Ratings

| | Storage Temperature RF Power Input | -55°C to +100°C |
|-------------------------------------|------------------------------------|-----------------|
| Operating Temperature -55°C to ±100 | Operating Temperature | |

Permanent damage may occur if any of these limits are exceeded.

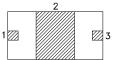
Electrical Specifications^{1,2} at 25°C

| Paran | neter | F# | Frequency (MHz) | Min. | Тур. | Max. | Unit |
|-------------------|-------------------|-------|-----------------|------|------|------|------|
| | Center Frequency | _ | | | 1802 | | MHz |
| Pass Band | Insertion Loss | F1-F2 | 1400-2320 | _ | 1.5 | 3.0 | dB |
| | Return Loss | F1-F2 | 1400-2320 | _ | 17 | _ | dB |
| Stop Band, Lower | Insertion Loss | DC-F3 | DC-1000 | 20 | 25 | _ | dB |
| Stop Band, Upper | Insertion Loss | F4-F5 | 3110-6700 | 20 | 33 | _ | dB |
| Stop Barid, Opper | IIISEI IIOII LOSS | F5-F6 | 6700-10000 | 15 | 24 | | |

- 1. Measured on Mini-Circuits Characterization Test Board TB-812+.
- 2. This filter is not intended for use as a DC Blocking circuit element. In Application where DC voltage is present at either input or output ports, blocking capacitors are required at the corresponding RF port.

Top View





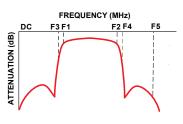
Pad Connections

| Input | 1 |
|--------|---|
| Output | 3 |
| Ground | 2 |

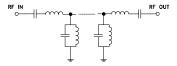
Typical Performance Data at 25°C

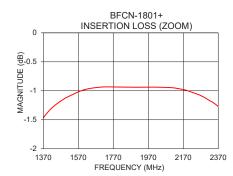
| Frequency (MHz) | Insertion Loss (dB) | Return Loss (dB) |
|--------------------|------------------------|---------------------|
| 200 | 69.27 | 0.02 |
| 500 | 33.17 | 0.16 |
| 1000 | 28.91 | 0.75 |
| 1200 | 7.29 | 4.00 |
| 1400 | 1.36 | 21.62 |
| 1800 | 0.94 | 18.65 |
| 2200 | 1.00 | 32.10 |
| 2600 | 4.82 | 4.69 |
| 3100 | 34.71 | 0.42 |
| 3500 | 39.25 | 0.24 |
| 4000 | 36.39 | 0.18 |
| 5000 | 33.44 | 0.30 |
| 6000 | 30.67 | 0.34 |
| 7000 | 31.32 | 0.41 |
| 8000 | 25.28 | 0.40 |

Specification Definition

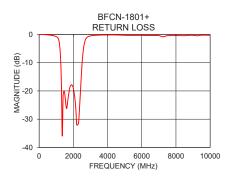


Functional Schematic

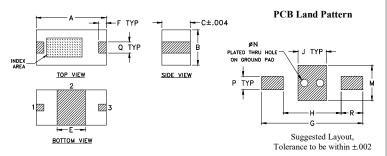








Outline Drawing



Product Marking: N/A

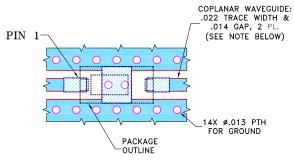
Pad Connections

| Input | 1 |
|--------|---|
| Output | 3 |
| Ground | 2 |

Outline Dimensions (inch)

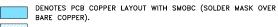
| Н | G | F | E | С | В | Α |
|-------|------|------|------|------|------|------|
| .104 | .183 | .014 | .051 | .051 | .063 | .126 |
| 2.64 | 4.65 | 0.36 | 1.30 | 1.30 | 1.60 | 3.20 |
| wt | R | Q | Р | N | М | J |
| | | | | | | |
| grams | .039 | .020 | .024 | | | .051 |

Demo Board MCL P/N: TB- 812+ Suggested PCB Layout (PL-439)



NOTES:

- 1. COPLANAR WAVEGUIDE IS SHOWN FOR ROGERS RO4350B WITH DIELECTRIC THICKNESS .010" ± .001". COPPER: 1/2 OZ. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH AND GAP MAY NEED TO BE MODIFIED.
 2. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.



DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK.

Additional Notes

- A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.
- B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuit's applicable established test performance criteria and measurement instructions.
- C. The parts covered by this specification document are subject to Mini-Circuits standard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the Standard Terms and the exclusive rights and remedies thereunder, please visit Mini-Circuits' website at www.minicircuits.com/MCLStore/terms.jsp

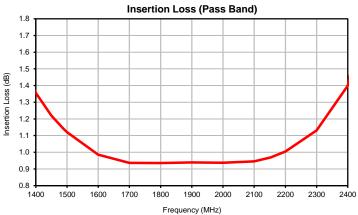


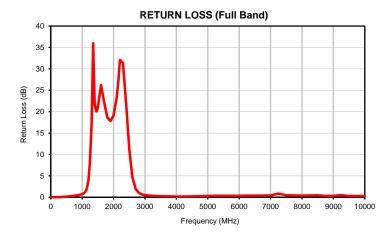
| FREQUENCY | INSERTION LOSS | RETURN LOSS |
|---------------|----------------|----------------|
| (MHz) | (dB) | (dB) |
| 10 | | ` ' |
| 55 | 73.63 62.92 | 0.02 0.00 |
| 100 | 59.37 | 0.00 |
| 200 | 69.27 | 0.02 |
| 300 | 48.50 | 0.05 |
| 400 500 | 38.98 33.17 | 0.09 0.16 |
| 600 | 29.14 | 0.10 |
| 700 | 26.28 | 0.32 |
| 800 | 24.47 | 0.42 |
| 900 | 24.24 | 0.55 0.75 |
| 1000 1050 | 28.91 32.63 | 0.75 0.94 |
| 1077 | 25.87 | 1.09 |
| 1100 | 20.80 | 1.29 |
| 1150 | 12.91 | 2.07 |
| 1200 1250 | 7.29 3.78 | 4.00 8.42 |
| 1300 | 2.18 | 6.42 17.34 |
| 1350 | 1.59 | 35.99 |
| 1400 | 1.36 | 21.62 |
| 1450 | 1.22 | 20.01 |
| 1488 1500 | 1.14 1.12 | 20.65 21.07 |
| 1600 | 0.99 | 26.24 |
| 1700 | 0.94 | 22.22 |
| 1800 | 0.94 | 18.65 |
| 1900 | 0.94 | 17.82 |
| 2000 2100 | 0.94 0.95 | 19.10 23.30 |
| 2153 | 0.97 | 27.30 |
| 2200 | 1.00 | 32.10 |
| 2300 | 1.13 | 31.41 |
| 2400 2500 | 1.40 2.24 | 21.84 11.08 |
| 2600 | 4.82 | 4.69 |
| 2700 | 9.53 | 1.98 |
| 2800 | 15.16 | 1.05 |
| 2900 | 21.08 | 0.69 |
| 2976 3100 | 25.78 34.71 | 0.54 0.42 |
| 3250 | 54.25 | 0.33 |
| 3500 | 39.25 | 0.24 |
| 3750 | 37.12 | 0.20 |
| 4000 4250 | 36.39 35.87 | 0.18 0.17 |
| 4500 | 35.30 | 0.17 |
| 4750 | 34.56 | 0.25 |
| 5000 | 33.44 | 0.30 |
| 5250 5500 | 32.25 31.47 | 0.35 0.35 |
| 5750 | 31.47 | 0.34 |
| 6000 | 30.67 | 0.34 |
| 6250 | 30.33 | 0.37 |
| 6500 | 30.05 | 0.38 |
| 6750 7000 | 30.10 31.32 | 0.39 0.41 |
| 7250 | 22.41 | 0.84 |
| 7500 | 25.07 | 0.44 |
| 7750 | 25.44 | 0.41 |
| 8000 | 25.28 | 0.40 |
| 8250 | 25.00 | 0.42 |
| 8500 | 25.58 | 0.45 |
| 8750 | 26.81 | 0.33 |
| 9000 | 25.76 | 0.32 |
| 9250 | 25.50 | 0.48 |
| 9500 | 26.73 | 0.28 |
| 9750 10000 | 25.91 25.25 | 0.27 0.32 |
| 10000 | 25.25 | 0.32 |

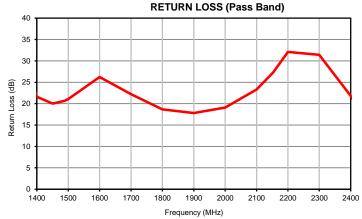










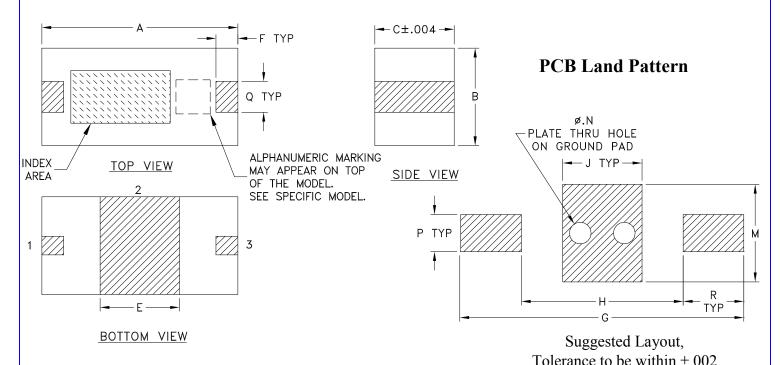


Case Style



FV1206-7

Outline Dimensions



| CASE # | A | В | С | D | Е | F | G | Н | J | K | L | M |
|----------|----------------|----------------|----------------|---|----------------|----------------|----------------|----------------|----------------|---|-----|----------------|
| FV1206-7 | .126 (3.20) | .063 (1.60) | .051 (1.30) | | .051 (1.30) | .014 (0.35) | .183 (4.65) | .104 (2.65) | .051 (1.30) | | 1 1 | .063 (1.60) |

| CASE # | N | P | Q | R | S | WT. GRAM |
|----------|----------------|----------------|----------------|----------------|---|----------|
| FV1206-7 | .014 (0.35) | .024 (0.60) | .020 (0.50) | .039 (1.00) | | .020 |

Dimensions are in inches (mm). Tolerances: 2 Pl. ± .01; 3 Pl. ± .005

Notes:

- 1. Open style, ceramic base.
- 2. Termination finish: as shown below or indicated on Data Sheet.

For RoHS Case Styles: Tin plate over Nickel plate. All models, (+) suffix.

For RoHS-5 Case Styles: Tin-Lead plate. All models, no (+) suffix.

3. Line width should be designed to match 50Ω characteristic impedance, depending on PCB material and thickness.





P.O. Box 350166, Brooklyn, New York 11235-0003 (718) 934-4500 Fax (718) 332-4661 For detailed performance specs & shopping online see Mini-Circuits web site

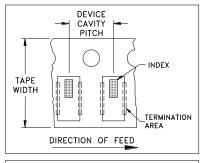
The Design Engineers Search Engine Provides ACTUAL Data Instantly From MINI-CIRCUITS At: www.minicircuits.com

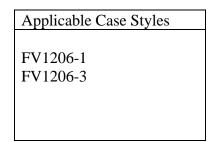
RF/IF MICROWAVE COMPONENTS

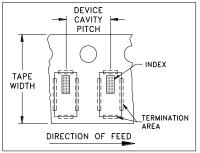
Tape & Reel Packaging

TR-F75

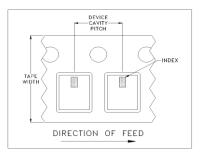
DEVICE ORIENTATION IN T&R







| Applicable Case Styles |
|------------------------|
| |
| FV1206-4 |
| FV1206-5 |
| FV1206-6 |
| FV1206-7 |
| FV1206-9 |



| A | pplicable Case Styles |
|---|-----------------------|
| F | V1206-12 |
| G | E0805C-18 |
| N | L1008C-6 |
| N | L1008C-7 |
| N | L1008C-9 |
| N | L1008C-10 |

ILLUSTRATION 3

ILLUSTRATION 1

ILLUSTRATION 2

| Tape Width, mm | Device Cavity Pitch, mm | Reel Size, inches | Devices 1 | per Reel |
|----------------|----------------------------|----------------------|------------|----------|
| | | | Small | 20 |
| | | | quantity | 50 |
| | | | standards | 100 |
| 8 | 4 | 7 | (see note) | 200 |
| | | | | 500 |
| | | | | 1000 |
| | | | Standard | 3000 |

Note: Please consult individual model data sheet to determine device per reel availability.

Mini-Circuits carrier tape materials provide protection from ESD (Electro-Static Discharge) during handling and transportation. Tapes are static dissipative and comply with industry standards EIA-481/EIA-541.

Go to: www.minicircuits.com/pages/pdfs/tape.pdf

Mini-Circuits ISO 9001 & ISO 14001 Certified



INTERNET http://www.minicircuits.com

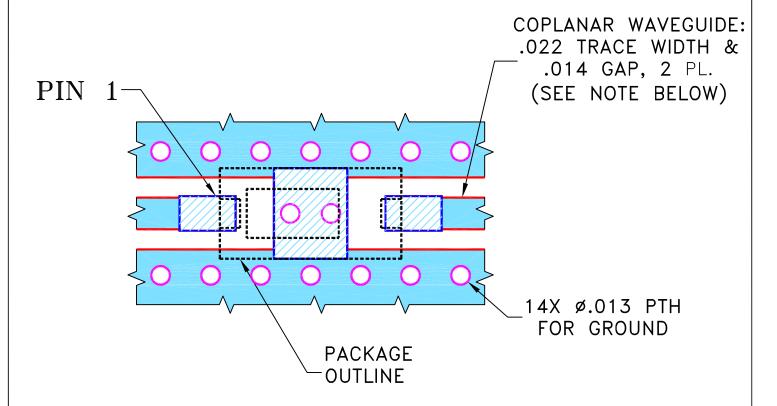
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THIRD ANGLE PROJECTION

| | | REVISIONS | | | |
|-----|---------|-------------|----------|----|------|
| REV | ECN No. | DESCRIPTION | DATE | DR | AUTH |
| OR | M148536 | NEW RELEASE | 10/14/14 | GF | MY |
| | | | | | |
| | | | | | |
| | | | | | |

SUGGESTED MOUNTING CONFIGURATION FOR FV1206-7 CASE STYLE, "03FL02" PIN CODE



NOTES:

- 1. COPLANAR WAVEGUIDE IS SHOWN FOR ROGERS RO4350B WITH DIELECTRIC THICKNESS .010" \pm .001". COPPER: 1/2 OZ. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH AND GAP MAY NEED TO BE MODIFIED.
- 2. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.



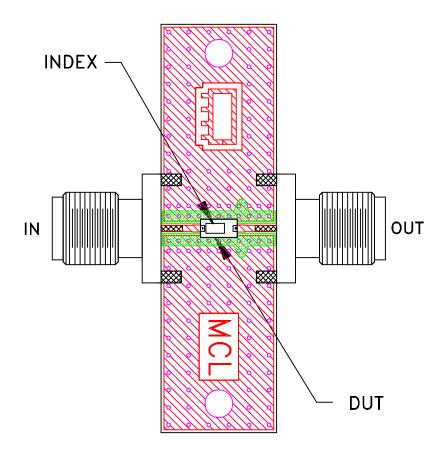
DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER).



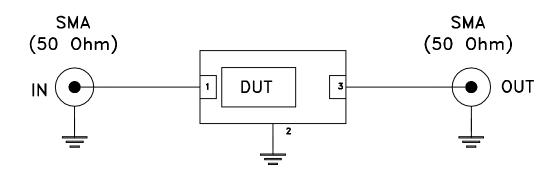
DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK.

| UNLESS OTHERWISE SPECIFIED | | INITIALS | DATE | | | . ~ | | • 4 R | | | |
|--|----------|----------|-----------|-------------------------------|----------------|---------------|--------|-------|-----------------------|---------|----|
| DIMENSIONS ARE IN INCHES | DRAWN | GF | 10/07/14 | | \square Mini | 1 – Ci | ırcu | 1ts | 13 Neptus Brooklyn | ne Aven | ue |
| TOLERANCES ON: 2 PL DECIMALS ± | CHECKED | AV | 10/14/14 | | Γ | | | | Бгоокіун | NI IIZ | 30 |
| 3 PL DECIMALS ± .005 ANGLES ± | APPROVED | MY | 10/14/14 | | | | | | | | |
| FRACTIONS ± | | | | PL, 03FL02, FV1206-7, TB-812+ | | | | :+ | | | |
| III Mini−Circuits ® | | | | | | | | | | | |
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| | | | FILE: (| 98PL439 | SCALE: | 15:1 | SHEET: | 1 | OF | 1 | |
| ASHEETA1.DWG REV:A DATE:01/12/95 | | ``` | 90FL439 | | 10:1 | | | | | | |

Evaluation Board and Circuit



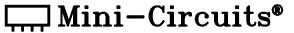
TB-812+



Schematic Diagram

Notes:

- 1. 50 Ohm SMA Female connectors.
- 2. PCB Material: RO4350 or equivalent, Dielectric Constant=3.5, Thickness=.010 inch.





Environmental Specifications

ENV06

All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

| Specification | Test/Inspection Condition | Reference/Spec | | | |
|----------------------------|---|--|--|--|--|
| Operating Temperature | -55° to 100°C Ambient Environment | Individual Model Data Sheet | | | |
| Storage Temperature | -55° to 100° C Ambient Environment | Individual Model Data Sheet | | | |
| Humidity | 90 to 95% RH, 240 hours, 50°C | MIL-STD-202, Method 103, Condition A, Except 50°C and end-point electrical test done within 12 hours | | | |
| Solder Reflow Heat | Sn-Pb Eutetic Process: 225°C peak Pb-Free Process 245° - 250°C peak | J-STD-020, Table 4-1, 4-2 and 5-2, Figure 5-1 | | | |
| Solderability | 10X Magnification | J-STD-002, Para 4.2.5, Test S, 95% Coverage | | | |
| Vibration (High Frequency) | 20g peak, 10-2000 Hz, 12 times in each of three perpendicular directions (total 36) | MIL-STD-202, Method 204, Condition D | | | |
| Mechanical Shock | 50g, 11 ms, 1/2-sine, 18 shocks: 3 each direction, each of 3 axes | MIL-STD-202, Method 213, Condition A | | | |

ENV06 Rev: A

(

02/25/11

M130240 File: ENV06.pdf